ALUMINUM ELECTROLYTIC CAPACITORS

3.95mmL MAX. Chip Type, Bi-polarized









• Chip type with 3.95mmL MAX, height.

- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.
- Compliant to the RoHS directive (2011/65/EU).

Products which are scheduled to be discontinued. Not recommended for new designs



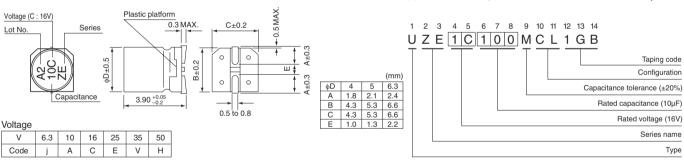


■Specifications

Item	Performance Characteristics												
Category Temperature Range	-40 to +85°C												
Rated Voltage Range	6.3 to 50V												
Rated Capacitance Range	0.1 to 47μF												
Capacitance Tolerance	±20% at 120Hz, 20°C												
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.05 CV or 10 (µA), whichever is greater.												
	Measurement frequency : 120Hz								∃z at 20°C				
Tangent of loss angle (tan δ)	Rated voltage (V)	6.3	10	_	16	25	_	35	50				
	tan δ (MAX.)	0.30	0.2	4	0.20	0.18	0	.16	0.16				
	Measurement frequency : 120Hz												
Stability at Low Temperature	Rated voltage (V)		6.3	10	16	25	5	35	50				
Stability at Low Temperature	Impedance ratio Z-25°C / Z-		4	3	2	2	_	2	2				
	ZT / Z20 (MAX.) Z-40°C / Z-	-20°C	8	8	4	4		3	3				
	The specifications listed at righ		Cap	acitance	citance change Within ±30% of the initial capacitance value								
Endurance	the capacitors are restored to 2				tan	δ		300	0% or less t	han the initial specified value			
	voltage is applied for 1000 hou polarity inverted every 250 hou		with th	ie	Lea	kage curi	ent	Les	ss than or e	qual to the initial specified value			
Shelf Life	After storing the capacitors und clause 4.1 at 20°C, they shall r								ing voltage treatment based on JIS C 5101-4 vristics listed above.				
	The capacitors are kept on a h			Cana	Capacitance change Within ±10% of the initial capacitance value								
Resistance to soldering	is maintained at 250°C. The ca			tan δ				an or equal to the initial specified value					
heat	characteristic requirements list removed from the plate and re-			they a	ire		ige cu	rrent	_	an or equal to the initial specified value			
Marking	Black print on the case top.												

■Chip Type

Type numbering system (Example: 16V 10µF)



Dimensions

	V	6.	.3	1	0	1	6	2	5	3	35	5	0
Cap. (µF)	Code	0	J	1.	A	1	С	1	E	1	V	1	Н
0.1	0R1		l I									4	1.0
0.22	R22		i I				i i					4	2.0
0.33	R33		l I		l I		I I					4	2.8
0.47	R47		 				!				!	4	4.0
1	010		İ									4	8.4
2.2	2R2		l I		l I		i I			4	8.4	5	13
3.3	3R3		l I		l I		!	5	12	5	16	5	17
4.7	4R7					4	12	5	16	5	18	6.3	20
10	100		İ	4	17	5	23	6.3	27	6.3	29		
22	220	5	28	6.3	33	6.3	37						
33	330	6.3	37	6.3	41	6.3	49						
47	470	6.3	45									Case size φD (mm)	Rated ripple

Rated ripple current (mArms) at 85°C 120Hz

Frequency coefficient of rated ripple current

and the state of t								
Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more			
Coefficient	0.70	1.00	1.17	1.36	1.50			

- Taping specifications are given in page 23.
- Recommended land size soldering by reflow are given in page 18,19.
- Please refer to page 3 for the minimum order quantity.

Type